



ELECTRONICS, INC.
 44 FARRAND STREET
 BLOOMFIELD, NJ 07003
 (973) 748-5089

NTE65101

Integrated Circuit

256 x 4–Bit Static Random Access Memory (SRAM)

Description:

The NTE65101 is a CMOS 1024–bit device organized in 256 words by 4 bits in a 22–Lead DIP type package. This device offers ultra low power and fully static operation with a single 5V supply. Separate data inputs and data outputs permit maximum flexibility in bus–oriented systems. Data retention at a power supply as low as 2V over temperature readily allows design into applications using battery backup for nonvolatility. The NTE65101 is fully static and does not require clocking in standby mode.

Features:

- Organized as 256 Bytes of 4–Bits
- Static Operation
- Low Standby Power
- Three–State Output
- Single 5V Power Supply
- Data Retention to 2V
- TTL Compatible
- Maximum Access Time: 450ns

Absolute Maximum Ratings: (Voltages referenced to V_{SS} Pin8)

Supply Voltage, V_{CC}	–0.5 to +7V
Input Voltage, V_{in}	–0.3 to $V_{CC} + 0.3V$
Operating Temperature Range, T_A	–40° to +85°C
Storage Temperature Range, T_{stg}	–65° to +150°C

Note 1. This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit.

DC Electrical Characteristics: ($V_{CC} = 5V \pm 5\%$, $T_A = 0^\circ$ to $+70^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Input Current	I_{in}	Note 3	–	5.0	–	nA
Input High Voltage	V_{IH}		2.2	–	V_{CC}	V
Input Low Voltage	V_{IL}		–0.3	–	0.65	V
Output High Voltage	V_{OH}	$I_{OH} = -1\text{mA}$	2.4	–	–	V
Output Low Voltage	V_{OL}	$I_{OL} = 2\text{mA}$	–	–	0.4	V
Output Leakage Current	I_{LO}	$\overline{CE}1 = 2.2\text{V}$, $V_{OL} = 0\text{V}$ to V_{CC} , Note 3	–	–	± 1.0	μA
Operating Current	I_{CC1}	$V_{in} = V_{CC}$, except $\overline{CE}1 \leq 0.65\text{V}$, Outputs open	–	9.0	22	mA
	I_{CC2}	$V_{in} = 2.2\text{V}$, except $\overline{CE}1 \leq 0.65\text{V}$, Outputs open	–	13	27	mA
Standby Current	I_{CCL}	$CE2 \leq 0.2\text{V}$, Note 3, Note 4	–	–	10	μA

Note 2. Typical values are $T_A = +25^\circ\text{C}$ and nominal voltage.

Note 3. Current through all inputs and outputs included in I_{CCL} measurement.

Note 4. Low current state is for $CE2 = 0$ only.

Capacitance:

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Input Capacitance	C_{in}	$V_{in} = 0\text{V}$	–	4.0	8.0	pF
Output Capacitance	C_{out}	$V_{out} = 0\text{V}$	–	8.0	12.0	pF

Note 2. Typical values are $T_A = +25^\circ\text{C}$ and nominal voltage.

Low V_{CC} Retention Characteristics: ($T_A = 0^\circ$ to $+70^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
V_{CC} for Data Retention	V_{DR}		2.0	–	–	V
Data Retention Current	I_{CCDR1}	$CE2 \leq 0.2\text{V}$, $V_{DR} = 2\text{V}$	–	0.14	10	μA
Chip Deselect to Data Retention Time	t_{CDR}		0	–	–	ns
Operation Recovery Time	t_R	Note 5	t_{RC}	–	–	ns

Note 2. Typical values are $T_A = +25^\circ\text{C}$ and nominal voltage.

Note 5. t_{RC} = Read Cycle Time.

AC Operating Conditions and Characteristics: (Full operating voltage and temperature unless otherwise specified)**AC Test Conditions:**

Condition	Value
Input Pulse Levels	+0.65V to 2.2V
Input Rise and Fall Times	20ns
Output Load –	1 TTL Gate and $C_L = 100\text{pF}$
Timing Measurement Reference Level	1.5V

AC Operating Conditions and Characteristics (Cont'd): (Full operating voltage and temperature unless otherwise specified)

Read Cycle:

Parameter	Symbol	Min	Max	Unit
Read Cycle Time	t_{RC}	450	–	ns
Access Time	t_A	–	450	ns

Read Cycle (Cont'd):

Parameter	Symbol	Min	Max	Unit
Address Setup Time	t_{AS}	20	–	ns
Address Hold Time	t_{AH}	0	–	ns
Chip Enable ($\overline{CE}1$) to Output	t_{CO1}	–	400	ns
Chip Enable (CE2) to Output	t_{CO2}	–	500	ns
Output Disable to Output	t_{OD}	–	250	ns
Data Output to High Z State	t_{DF}	0	130	ns
Previous Read Data Valid with Respect to Address Change	t_{OH1}	0	–	ns
Previous Read Data Valid with Respect to Chip Enable	t_{OH2}	0	–	ns

Write Cycle:

Parameter	Symbol	Min	Max	Unit
Write Cycle	t_{WC}	450	–	ns
Write Delay	t_{AW}	130	–	ns
Chip Enable ($\overline{CE}1$) to Write	t_{CW1}	350	–	ns
Chip Enable (CE2) to Write	t_{CW2}	350	–	ns
Data Setup	t_{DW}	250	–	ns
Data Hold	t_{DH}	50	–	ns
Write Pulse	t_{WP}	250	–	ns
Write Recovery	t_{WR}	50	–	ns
Output Disable Setup	t_{DS}	130	–	ns

Truth Table:

$\overline{CE}1$	CE2	OD	R/W	D_{in}	Output	Mode
H	X	X	X	X	High Z	Not Selected
X	L	X	X	X	High Z	Not Selected
X	X	H	H	X	High Z	Output Disable
L	H	H	L	X	High Z	Write
L	H	L	L	X	D_{in}	Write
L	H	L	H	X	D_{out}	Read

Pin Connection Diagram

A3	1	22	V _{CC}
A2	2	21	A4
A1	3	20	R/W
A0	4	19	\overline{CE} 1
A5	5	18	OD
A6	6	17	CD 2
A7	7	16	DO 4
GND	8	15	DI 4
DI 1	9	14	DO 3
DO 1	10	13	DI 3
DI 2	11	12	DO 2

